

15th Technical Forum 2019

DATE Thursday, January 31st, 2019
TIME 13.30 pm
LOCATION Estrel Congress Center – Hall Europe
MODERATORS Dieter Merkle, Schuler Pressen and Thomas Hogenkamp, Spaleck

We thank our partners for their support in the realization of the Technical Forum.



TOPIC	TIME	COMPANY	SPEAKER	TITLE
	13.30	Welcome and opening remarks		
Environment	13.45	Istituto Poligrafico e Zecca dello Stato	Paolo Mascioli Carmelo Mirabile	Reduced thickness copper layer on plated blanks – without cyanide
	14.00	Monea	Thomas Königer Marius Straub	Free of Waste Water
	14.15	Spaleck Oberflächentechnik GmbH & Co. KG	Karin Geukes	Waste Water Recycling – Keep it simple!
Tooling Laser	14.30	ACSYS Lasertechnik GmbH	Alexander Aminidis	Unleash Laser Frosting
Surface Finishing	14.45	Rösler Oberflächentechnik GmbH	Rüdiger Böhm	New Coin Finishing System for collector and commemorative coins
	15.00	Time for Questions and Answers		
	15.15	<i>Break sponsored by Allgemeine Gold- und Silberscheideanstalt AG</i>		
Production Process – Tri-Metal	15.40	Royal Canadian Mint	Dr. Xianyao Li	Next generation circulation coin – phase one development
Production Process – Material Combination	15.55	Imprensa Nacional Casa da Moeda	Prof. Paulo A. F. Martins	A new polymer-metal coin
	16.10	Schuler Pressen GmbH	Wolfgang Schumann	Save your Coin – Phase One – Two become Three
Minting	16.25	United States Mint	Ronald E. Harrigal	2019 Apollo Commemorative Coin Program Challenges and Results
Production Planning & Control	16.40	Münz-Prägstatt GmbH	Jochen Diessner	Customer satisfaction with Production Planning & Controlling
	16.55	Time for Questions and Answers		
	17.10	<i>Break sponsored by Allgemeine Gold- und Silberscheideanstalt AG</i>		
Inspection	17.35	Mühlbauer GmbH & Co. KG	Dr. Ralf Freiberger	Modern coin and blank inspection: driving the detection performance with different sensors to its limits.
	17.50	Spookfish UK	Dr. Anupriya Balikai	Next Generation Coin Inspection: Intelligent Machines
	18.05	InduVis	Lutz Büker	New Aspects for the Inline Inspection Technology
Tooling Software	18.20	CarveCo Ltd	Robert Newman Timothy Buck	‘CarveCo, an icon reborn’ ‘Future Design and Overt Security’
Chances & Challenges	18.35	Mint of Finland Ltd.	Jonne Hankimaa	The Future of Payments
	18.50	Time for Questions and Answers		
	19.05	Conclusion of the Technical Forum with a view to current and future challenges for the coin community “Cash Matters”	Dieter Merkle	
	19.20 – 22.30	Get-Together with Drinks and Snacks in the “Technical” Exhibition Area for registered delegates of the Technical Forum in Convention Hall II	sponsored by Spaleck and Schuler Pressen	